


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	AMS/19/11324	
1.3 Title of PCI	Transfer of TnF from SHENZEN to BOUSKOURA.	
1.4 Product Category	See Products List (MV30-U1K9-U1M0)	
1.5 Issue date	2019-02-01	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	MARSHALL DAVE
2.1.2 Phone	
2.1.3 Email	dave.marshall@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Domenico ARRIGO
2.1.2 Marketing Manager	Fulvio PULICELLI
2.1.3 Quality Manager	Alessandro PLATINI

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Testing (SOP 2617)	BOUSKOURA

4. Description of change

	Old	New
4.1 Description	SHENZEN as TnF site.	BOUSKOURA as TnF site.
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change

5.1 Motivation	The transfer of TnF from Shenzhen to Bouskoura increases the efficiency as well the production capacity. Customers demand will be better supported.
5.2 Customer Benefit	SERVICE IMPROVEMENT

6. Marking of parts / traceability of change

6.1 Description	New FGs
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7. Timing / schedule

7.1 Date of qualification results	2019-03-31
7.2 Intended start of delivery	2019-05-01
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

9. Attachments (additional documentations)

11324 Public product.pdf

10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	L6494LDTR	
	L6498LD	

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